

Acron P/N: GDR15-N3-081A300 (TRAY PACKING) GDR15-N3-081A100 (TAPE REEL)

育鼎精密工業股份有限公司 ACRON PRECISION INDUSTRIAL CO., LTD

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□東莞睦永電子五金廠 (AMMI)				□東莞育鼎電子五金廠 (ACRON)			■東莞愷興電子科技電子有限公司 (NUCONN)		
REVISION: ECR/ECN INFORMATION:			ON:	PRODUCT NO		GDR15 Series			SHEET No
G	EC No: DATE:	RD-T1600 2016/11/	_	PRODUCT NAME	With	out transfor R/A Dip	_	D RJ45	1 of 9
PS-GD-0007			-	REATED / REVISED BY: CHECKE ANDELEE.YANG JERRY.		D BY:	<u>approv</u> Kimi. i		



PRODUCT CHANGING HISTORY

NO	DATE	Changing	REV	Made	Approved
1	10/12'10	NEW	Α	Liang.Wu	Devin Chen
2	01/25'11	ADD REFLOW TEST SPECIFICATION	В	Liang.Wu	Devin Chen
3	06/11'14	ADD PRODUCT SPECIFICATION	С	Ryan.Wu	Kimi.Hsu
4	06/11'14	RDT-140140	D	Ryan.Wu	Kimi.Hsu
5	06/20'14	RDT-140166	Е	Andelee	Kimi.Hsu
6	07/07'14	RDT-140179	F	Andelee	Kimi.Hsu
7	11/24'16	RD-T160051	G	Andelee	Kimi.Hsu
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REVISION:	ECR/ECN INFORMATION:		PRODUCT NO		GDR15 Series (Sharp)			
G	EC No: DATE:	RD-T160 2016/11/		PRODUCT Without transformer /LED RJ45 R/A Dip type		D RJ45	2 of 9	
DOCUMENT NUMBER: CRE			EATED / REVISED BY:		CHECKED BY:	APPROVED BY:		
PS-GD-0007			ANDELEE.YANG JERRY.TUNG KIMI.I			HSU		



1.0 SCOPE

This Product Specification covers the performance requirements for Without transformer/LED RJ45 R/A Dip type series

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Acron part No: GDR15-N3-081A300 (Tray packing) GDR15-N3-081A100 (Tape reel packing)

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See appropriate sales drawings for details on dimensions, materials, plating and markings.

2.3 SAFETY AGENCY APPROVALS

See appropriate sales drawings

2.4 PRODUCT WEIGHT

The product weight is 2.711g

2.5 PRODUCING PLANT FACTORY AND ADDRESS

Producing plant factory: Nuconn Industry CORP Nuconn Industry CORP. Address: 32# No. 2 Road 3th IND. Shang Sha, ChangAn, Dong Guan, Guang Dong, China

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

Please refer to the Sales Drawings , and other sections of this Specification for specific references to applicable documents and specifications. In cases where the Product Specification differs from the Sales Drawings, the Sales Drawing will take precedence

EIA-364 TEST METHODS FOR ELECTRICAL CONNECTORS

4.0 RATINGS

TEMPERATURE

Operating Temperature Range: -25°C to +80°C Storage Temperature Range: - 25°C to + 60°C

Voltage Rating: AC 125V Current Rating: 1A

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5.0 PERFORMANCE

Item	Test Items	Requirement	Procedures
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual, dimensional and functional per applicable quality inspection plan.

	Electrical Requirements								
2	LOW Level Contact Resistance	50 m Ω max initial Δ R = 50 m Ω max final	Mate subject connector with compatible connector. EIA-364-23B						
3	Insulation Resistance	1000 M Ω min initial 50 M Ω min final	Apply 100±10% Volts DC between adjacent contacts of mated connectors for one minute. EIA-364-21						
4	Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1m A max	For mated specimens, AC 1500 V between connected RJ interface contacts and all PCB tails connected together with shield. 1 milliamp ere cutoff current, 1 A Volts per second maximum ramp. EIA-364-20D						

	Mechanical Requirements								
5	Mating and Un- mating Forces	Insertion Force:22N max Unlatched Withdrawal Force: 22N max Latched Withdrawal Force: 89N min	Measure force necessary to mate and un-mate connectors using the free floating fixtures at rate of 25mm/min. EIA-364-05B						
6	Solder ability	Wetting must occur over at least 95% of the solder immersion surface	(1) SN/3.0Ag/0.5Cu(weight/%), (2) Flux: ROSN 25%,PA 75%. (3) High Temp Storage:150°C 1 hour, (4)PCT: 105°C 100% 1.22*105Pa 4 hours. (5)Solder 240°C±2°C; Immersion depth 2mm; Immersion time 3S						
7	Terminal Strength	Appearance meet requirement	Gravitation 500g , Winding 90 angle 2-3sec						
8	Physical Shock	No electrical discontinuity greater than 1µsecond. Shall meet visual requirements, and show no physical damages.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test						

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DOCUMENT NUMBER: CRE		CRE	ATED / REVISE	ATED / REVISED BY: CHECKED BY: APPI		<u>APPROV</u>	ED BY:	
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DOCUMENT NUMBER:

PS-GD-0007

PRODUCT SPECIFICATION

NO SERVICE (CISE)	G EC No: RD-T160 DATE: 2016/11			PRODUCT NAME		ansformer /LED RJ45 R/A Dip type	5 of 9		
Solder Joint Strength Test	REVISIO	<u>N:</u>						<u> </u>	SHEET NO
Solder Joint Strength Test Solder Joint Strength Test 10 Durability Solder Selection Se	11	11 Random Vibration		than requi	than 1µsecond. Shall meet visual requirements, and show no		100mA maximum for all contacts. Subject to a simple harmonic mot having amplitude of 0.76mm (1.5 maximum total excursion) in frequency the approximate limits of 10 and 5. The entire frequency range, from 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minus This motion shall be applied for 2 hours in each of three mutually perpendicular directions.	tion 2mm uency veen 55 Hz. 10 to oe ute.	
9 Solder Joint Strength Test (1) The variation must be 50% ≤ of the initial value (2) After test measured items must be 75% ≤ of solder (Pb/Sn) item (1) The variation must be 50% ≤ of solder (Pb/Sn) item (1) The variation must be 50% ≤ of solder (Pb/Sn) item (1) The variation must be 50% ≤ of solder (Pb/Sn) item (1) The variation must be 50% ≤ of the initial value (2) After test measured items must be 75% ≤ of solder (Pb/Sn) item (2) After lest measured items must be 75% ≤ of solder (Pb/Sn) item (3) Measurement Item: Component with LEAD: Tension Test (EIAJED-4702); Component with LEAD: Tension Test (EIAJED-4702) (4) Measurement cycle: INITIAL,(100) 200 (5) Measurement SMPL: Component with LEAD: 5LEADS ≤ Component with LEAD: 5POINTS ≤ To calculate Average	10	0 Durability			damage for RJ-45. Low Level Contact Resistance:		Resistance:	tester and fully mated and unmated 300 times per hour at the rate of 25mm/min.	
load condition shall be 100mA maximum for all contacts.	9			Strength	≦ of (2) A must	f the initial valu fter test measu	e ıred items	(1)Prepare Sample: A: flow type: SN/3.0Ag/0.5Cu,Cream sold type: 250°C 2~5s B: Reflow type: 150±20um(print thickness) Peak temperature:240 MAX 220°C min. 40S≦ Preheat 150~190°C 90±30S (2)Temp Cycle Test Min Temp: -40°C. MAX TEMP:+125°CTIME: Each 30 CYCLES:200 (3) Measurement Item: Component with LEAD: Tensi Test (EIAJED-4702); Componwithout LEAD: Bend Test (EIA 4702) (4) Measurement cycle: INITIAL,(200 (5) Measurement SMPL: Component with LEAD: 5LEA Component without LEAD: 5POINTS≦ To calculate Aver	5S≧ min. on nent AJED- (100) DS≦
								load condition shall be 100mA maximum for all contacts.	rical

CREATED / REVISED BY:

ANDELEE.YANG

CHECKED BY:

JERRY.TUNG

APPROVED BY:

KIMI.HSU



			Left: 100N, push 15sec
12	KOJIRI Strength	Appearance meet requirement	Right: 100N, push 15sec
12	KOJIKI Strength		Up: 100N, push 15sec
			Down: 100N, push 15se

	Environment Requirements								
13	Thermal Shock (Simulate Non- Operating State)	\triangle R: 50m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to 100 cycles between -40°C and 85°C, 30 minutes duration at both temperature extremes. EIA-364-32C						
14	Humidity- Temperature Cycling	\triangle R: 50m Ω max (change from initial) & Appearance: no damage	Mated connectors placed in humidity chamber (Humidity 80-98%, Temperature 20-65°C) for 500 Hrs. EIA-364-31B, Method IV, Except 7a						
15	Temperature Life (Heat Aging)	\triangle R: 50m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at 85°C for 500 hours. EIA-364-17B, Method A						
16	Temperature Life (Cold Aging)	\triangle R: 50m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at-40°C for 500 hours EIA-364-17B, Method A						
17	Salt Spray	\triangle R: 50m Ω max (change from initial) & Appearance: no damage	8hours moving 16hours resting total 24hours 3cycles Atmosphere: salt spray from a 5% solution. Temperature: 35 +1/-2°C EIA 364-26						
18	Change of Temperature	JIS C 0025 JEC Pub.68 2-14 NA MIL-STD-202 102A (Unless otherwise specified, either method 1or method 2. is to be closen)	Metod1 To (Both Method I and 2 are be performed under following conditions) Stage Temp Time						
19	Damp Heat, Steady State	JIS C 0022 JEC Pub.68 2-3 Ca MIL-STD-202 103B	Test Temp :40±2℃ Relative Humidity:90∼95%RH Test time:500Hrs						

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	DATE:	2016/11/	24	IVAIVIL		R/A Dip type		
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20	Ammonia	Appearance: no damage	Hydrogen Ion Exponent Index (PH)=10 Test Temperature:15~35℃ Test Time:72±4hrs			
21	Soldering Heat	1: Electrical and mechanical performance must be satisfactory in specifications 2:There must no conspicuous changes in appearance(For example warping, swelling, cracking, indication)	MATERIALS Solder: Sn/3.0Ag/0.5Cu(weight/%), If no doubts araise in judgment, it is ok to use another SOLDER TEST CONDITION 1.TEST A: Hand Soldering 400°C (Soldering iron tiop) 3S ≤ 2.TEST B: flow soldering(whole heating): 260°C 5S ≤ (Preheating 100~120°C 70s ≤) 3.TEST C: Reflow soldering: Peak temperature:240 MAX 5S ≥ 220°C min. 40S ≤ Preheat 150~190°C 90±30S The reflow count is 2 times or more			
	Drop test		Testing Method Individual packing per			
22		Appearance: no damage Electrical function OK	B Fall floor surface (or equivalent thing)			
			C Fall height 1m D Fall position X/Y/Z			
			E The number of times fall 2 times each			
			F Fall method Free fall			

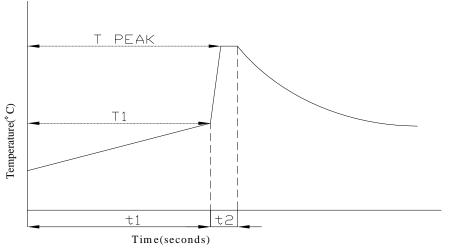
6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. See packaging appropriate drawings

7.0 RECOMMENDED FLOW SOLDERING PROFILE

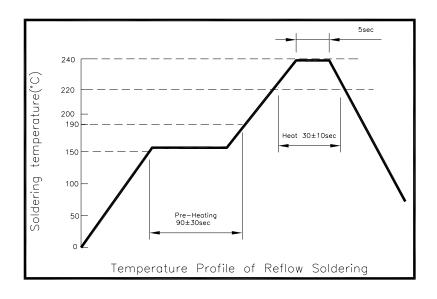
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PARAMETER	REFERENCE	LEAD FREE SPECIFICATION
PREHEAT TEMPERATURE GRADIENT		+1~4℃/sec
PREHEAT TIME	t1	70 sec
PREHEAT TEMPERATURE	T1	100 ~120℃
SOLDER POT TEMPERATURE	T PEAK	260 ℃
DWELL TIME	t2	5 SEC
PEAK BOARD TOP TEMPERATURE		190℃
COOLING TEMPERATURE GRADIENT		-6℃/SEC MAX.

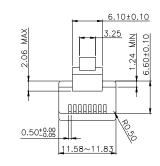
8.0 RECOMMENDED REFLOW PROFILE



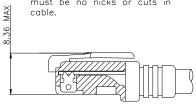
9.0 RECOMMENDED RJ PLUG SPECIFICATION

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* There must be no damage to housing or locking latch.There must be no nicks or cuts in



FOLLOW SPECIFICATION: FCC, PART 68, SUBPART F FIGURE 68.500 (C)(2)(ii)

	0.89 MIN 2.34 MAX 25 X 2 X 2 X 2 X	12.32 MIN
6.15 CRIMP HEIGHT	All contacts recessed below top of housing a and must be at the same height approximately	FOLLOW SPECIFICATION: FCC, PART 68, SUBPART F FIGURE 68.500 (C)(2)(i) AND IEC 603-7 FIGURE 23 & 24

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ACRON 文件制訂、修訂、廢止申請單

RD-PS-A-001-118

	RD-PS-A-001-110				
文件編號	PS-GD-000)	文件名稱	GDR,	5 Sonies	(Sharp)
申請部門	研發部	申請人	Indelec	日期	
制訂單位	研發部	制訂人	Andree	日期	11.242016
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